

### LESD7D3.3T5G ESD PROTECTION DIODE

### **Discription**

The LESD7D3.3T5G is designed to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space is at a premium.

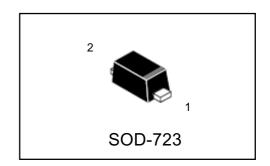
### **Applications**

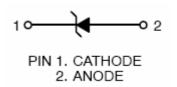
- I Cellular phones audio
- I MP3 players
- I Digital cameras
- I Portable applicationss
- I mobile telephone

#### **Features**

- Small Body Outline Dimensions: 0.039" x 0.024"(1.0 mm x 0.60 mm)
- Low Body Height: 0.017" (0.43 mm) Max
- Stand-off Voltage: 3.3 V 12 V
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- IEC61000-4-2 Level 4 ESD Protection
- We declare that the material of product compliance with RoHS requirements.
- S- Prefix for Automotive and Other Applications
  Requiring Unique Site and Control Change
  Requirements; AEC-Q101 Qualified and PPAP Capable.

# LESD7D3.3T5G S-LESD7D3.3T5G





#### Ordering information

Device	Marking	Shipping			
LESD7D3.3T5G S-LESD7D3.3T5G	А	8000/Tape&Reel			

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
IEC61000-4-2 (ESD)	air discharge contact discharge	±15 ±8	KV
ESD Voltage Per Human Body Model		16	kV
Total Power Dissipation on FR-5 Board (Note 1)	PD	150	Mw
@ T <sub>A</sub> =25℃			
Junction and Storage Temperature Range	TJ,TSTG	-55 to 150	$^{\circ}$ C
Lead Solder Temperature – Maximum (10	TL	260	$^{\circ}$
Second Duration)			

Stresses exceeding Maximum Ratings may damage the device. Maximum Rating are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-5 = 1.0\*0.75\*0.62 in.

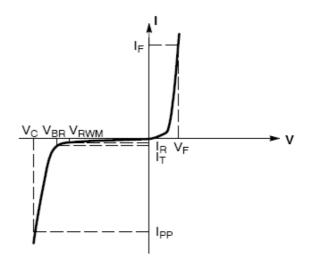


# LESD7D3.3T5G, S-LESD7D3.3T5G

#### **ELECTRICAL CHARACTERISTICS**

(TA = 25°C unless otherwise noted)

Symbol	Parameter					
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current					
V <sub>C</sub>	Clamping Voltage @ I <sub>PP</sub>					
V <sub>RWM</sub>	Working Peak Reverse Voltage					
I <sub>R</sub>	Maximum Reverse Leakage Current @ V <sub>RWM</sub>					
V <sub>BR</sub>	Breakdown Voltage @ I <sub>T</sub>					
I <sub>T</sub>	Test Current					
I <sub>F</sub>	Forward Current					
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>					
P <sub>pk</sub>	Peak Power Dissipation					
С	Max. Capacitance @V <sub>R</sub> = 0 and f = 1 MHz					



Uni-Directional TVS

### ELECTRICAL CHARACTERISTICS (T<sub>A</sub>=25°C unless otherwise noted, VF=0.9V Max. @ IF=10Ma for all types)

	$V_{RWM}$	I <sub>R</sub>	$V_{BR}$	Ι <sub>Τ</sub>	I <sub>PP</sub>	Vc	P <sub>PK</sub>	С
	(V)	( µ A)	(V)	(mA)	(A)	(V)	(W)	(pF)
Device		@	@ I <sub>T</sub>			@ Max I <sub>PP</sub>	(8*20 µs)	
		$V_{RWM}$	(Note 2)		(Note 3)	(Note 3)		
	Max	Max	Min		Max	Max	Тур	Тур
LESD7D3.3T5G	3.3	2.5	5.0	1.0	9.8	10.4	102	80
LESD7D5.0T5G	5.0	1.0	6.2	1.0	8.7	12.3	107	65

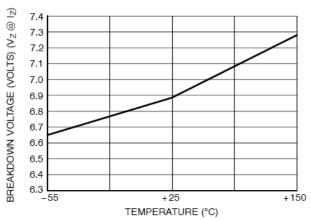
Other voltage available upon request.

- 3. Surge current waveform per Figure 3.



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#### TYPICAL CHARACTERISTICS



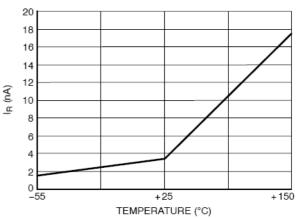


Figure 1. Typical Breakdown Voltage versus Temperature

Fig 2. Typical Leakage Current versus
Temperature

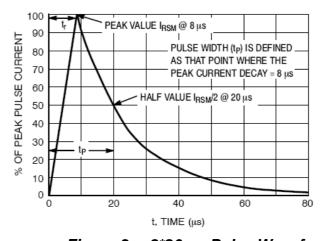


Figure 3. 8\*20 µs Pulse Waveform

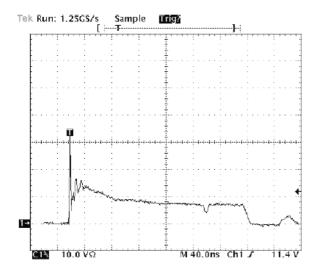


Figure 4. Positive 8kV contact per IEC 61000-4-2-LESD7D5.0T5G

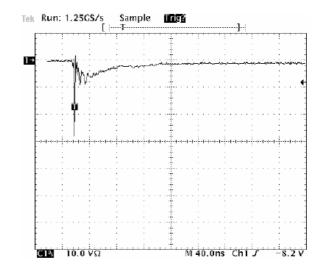
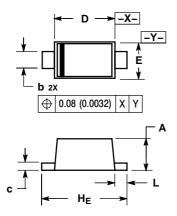


Fig 5. Negative 8kV contact per IEC 61000-4-2-LESD7D5.0T5G



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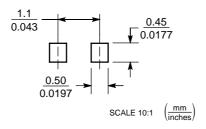
#### SOD-723



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	MIL	LIMETE	ERS	INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.49	0.52	0.55	0.019	0.020	0.022	
b	0.25	0.28	0.32	0.0098	0.011	0.013	
С	0.08	0.12	0.15	0.0032	0.0047	0.0059	
D	0.95	1.00	1.05	0.037	0.039	0.041	
Е	0.55	0.60	0.65	0.022	0.024	0.026	
HE	1.35	1.40	1.45	0.053	0.055	0.057	
L	0.15	0.20	0.25	0.006	0.0079	0.010	

#### **SOLDERING FOOTPRINT\***



单击下面可查看定价,库存,交付和生命周期等信息

>>LRC(乐山无线电)